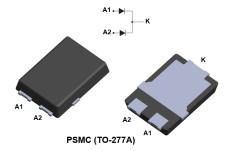


## Automotive 40 V, dual 3 A power Schottky rectifier



#### **Features**



- PPAP capable
- 150 °C maximum operation junction temperature
- V<sub>RRM</sub> guaranteed from -40 °C to 150 °C
- · High surge current capability
- ECOPACK2 compliant component

#### **Application**

- · Reverse polarity protection in E.C.U
- DC/DC converters
- Freewheeling diodes

#### **Description**

The STPS640CSFY has been developed for applications requiring an optimized VF and leakage current characteristics.

These characteristics make it ideal for use in secondary rectification functions, such as DC/DC converters or freewheeling functions.

Product status link
STPS640CSFY

Product summary			
Symbol	Value		
I <sub>F(AV)</sub>	2 X 3 A		
V <sub>RRM</sub>	40 V		
T <sub>j</sub> (max.)	150 °C		
V <sub>F</sub> (typ.)	0.37 V		



### 1 Characteristics

Table 1. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

Symbol	Р	Value	Unit		
$V_{RRM}$	Repetitive peak reverse voltage (T <sub>j</sub> = -40 °C to +150 °C)			40	V
1	Average forward current \$ = 0.5	Per diode	T <sub>C</sub> = 140 °C	3	Α
I <sub>F(AV)</sub>	Average forward current, $\delta = 0.5$	Per device	T <sub>C</sub> = 140 °C	6	A
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$			120	Α
P <sub>ARM</sub>	Repetitive peak avalanche power $t_p$ = 10 $\mu$ s, $T_j$ = 125 $^{\circ}$ C			100	W
T <sub>stg</sub>	Storage temperature range			-65 to +175	°C
T <sub>j</sub>	Operating junction temperature range <sup>(1)</sup>			-40 to +150	°C

<sup>1.</sup>  $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

Symbol	Parameter	Тур.	Unit
R <sub>th(j-c)</sub>	Junction to case total	1.5	°C/W

For more information, please refer to the following application note:

• AN5088: Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I_ (1)	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 25 °C	$V_R = V_{RRM}$	-		75	μA
IR <sup>(*)</sup>		T <sub>j</sub> = 125 °C		-	20	30	mA
	V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 3 A	-	0.44	0.49	
		T <sub>j</sub> = 125 °C		-	0.37	0.43	
V <sub>-</sub> (2)		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 4 A	-	0.47	0.52	V
VF.		T <sub>j</sub> = 125 °C		-	0.42	0.48	V
		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 6 A	-	0.52	0.58	
		T <sub>j</sub> = 125 °C		-	0.50	0.57	

<sup>1.</sup> Pulse test:  $t_p = 5$  ms,  $\delta < 2\%$ 

To evaluate the conduction losses, use the following equation:

$$P = 0.23 \times I_{F(AV)} + 0.067 \times I_{F}^{2}_{(RMS)}$$

For more information, please refer to the following application notes related to the power losses:

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses in a power diode

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<sup>2.</sup> Pulse test:  $t_p = 380 \ \mu s, \ \delta < 2\%$ 





### 1.1 Characteristics (curves)

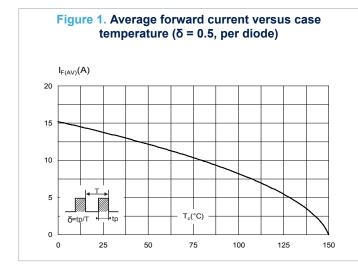
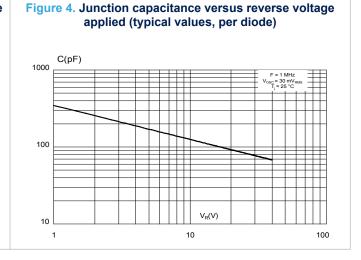
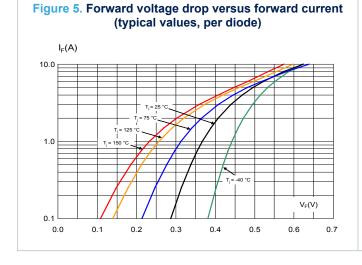
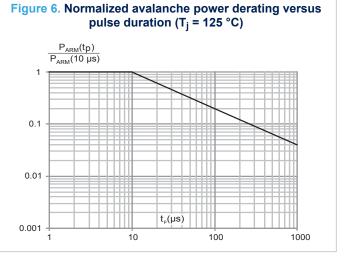


Figure 2. Relative variation of thermal impedance junction to case versus pulse duration  $Z_{th(j-c)}/R_{th(j-c)}$ 1.0 0.9 0.8 0.7 0.6 0.5 0.4 0.3 0.2 0.1 0.0 1.E-04 1.E-03 1.E-02 1.E-01 1.E+00



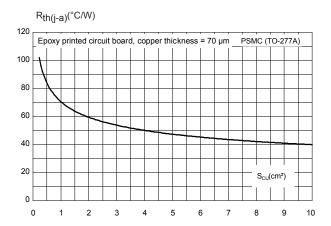




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Figure 7. Thermal resistance junction to ambient versus copper surface under tab (typical values, epoxy printed board FR4,  $e_{Cu}$  = 70  $\mu$ m) (PSMC (TO-277A))



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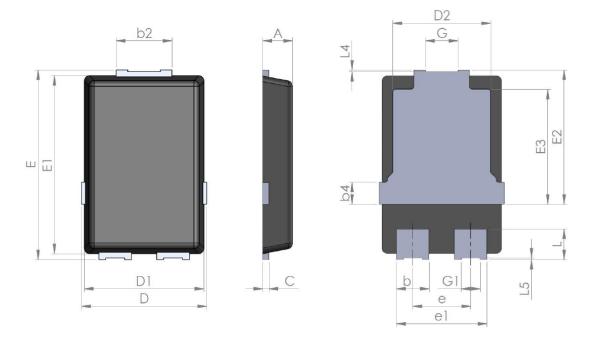
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

### 2.1 PSMC (TO-277A) package information

- Epoxy meets UL94,V0
- Cooling method : by conduction (C)

Figure 8. PSMC (TO-277A) package outline



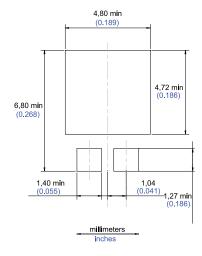
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Table 4. PSMC (TO-277A) package mechanical data

	Dimensions					
Ref.		Millimeters		Incl	only)	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	1.00	1.10	1.20	0.039	0.043	0.047
b	1.05	1.20	1.35	0.041	0.047	0.053
b2	1.90	2.05	2.20	0.075	0.081	0.087
b4		0.75			0.029	
С	0.15	0.23	0.40	0.006	0.009	0.016
D	4.45	4.60	4.75	0.175	0.181	0.187
D1	4.25	4.40	4.45	0.167	0.173	0.175
D2	3.40	3.60	3.70	0.134	0.142	0.146
E	6.35	6.50	6.65	0.250	0.256	0.262
E1	6.05	6.10	6.15	0.238	0.240	0.242
E2	4.50	4.60	4.70	0.177	0.181	0.185
E3		3.94			1.55	
е		2.13			0.084	
e1		3.33			0.131	
G		1.20			0.047	
G1		0.70			0.027	
L	0.90	1.05	1.24	0.035	0.041	0.049
L4	0.02			0.0008		
L5	0.02			0.0008		

Figure 9. PSMC (TO-277A) package footprint in mm (in inches)



Note: For package and tape orientation, reel and inner box dimensions and tape outline please check TN1173

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# **3** Ordering information

**Table 5. Ordering information** 

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS640CSFY	PS640CY	PSMC (TO-277A)	90 mg	6000	Tape and Reel

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## **Revision history**

**Table 6. Document revision history** 

Date	Version	Changes
26-Oct-2020	1	Initial release.

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